1.6mΩ, 30V, N-Channel Power MOSFET SRT03N016L

General Description

The Sanrise SRT03N016L is a high voltage power MOSFET, fabricated using advanced super junction technology. The resulting device has extremely low on resistance, low gate charge and fast switching time, making it especially suitable for applications which require superior power density and outstanding efficiency.

The SRT03N016L break down voltage is 30V and it has a high rugged avalanche characteristics.

The SRT03N016L is available in PDFN5*6 package.

Symbol

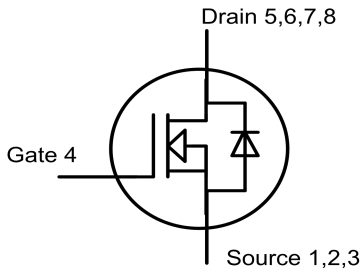
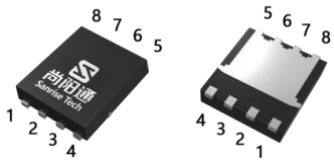


Figure 1 Symbol of SRT03N016L

Features

- Ultra Low $R_{DS(ON)}$ = 1.35mΩ @ V_{GS} = 10V.
- Ultra Low Gate Charge, Qg=48.2nC typ.
- Fast switching capability
- Robust design with better EAS performance
- Non-automotive Qualified

Package Type



PDFN5*6

Figure 2 Package Types of SRT03N016L

Application

- Server / Telecom
- High Power Supply, such as DCDC converter
- Motor Driver, such as E-Tools
- BMS

Ordering Information

SRT03N016L□□–□

Circuit Type

Package
D56: PDFN5*6

E: Lead Free
G: Green

Blank: Tube
TR: Tape & Reel

Package	Part Number	Marking ID	Packing Type
PDFN5*6	SRT03N016LD56TR-G	SRT03N016LD56G	Tape & Reel

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Absolute Maximum Ratings

Parameter		Symbol	Rating	Unit
Drain-Source Voltage		V_{DSS}	30	V
Gate-Source Voltage		V_{GSS}	±20	V
Continuous Drain Current	T_C=25ºC	I_D	163	A
	T_C=100ºC		103	
Pulsed Drain Current (Note 2)		I_{DM}	652	A
Power Dissipation (T_C = 25°C)		P_D	90	W
Avalanche Destructive Energy, Single Pulse (Note 4)		E_{AS_Limit}	324	mJ
Avalanche Energy, Single Pulse (Note 3)		E_{AS}	56	mJ
Avalanche Current, Repetitive (Note 2)		I_{AR}	15.0	A
Operating Junction Temperature		T_J	150	ºC
Storage Temperature		T_{STG}	-55 to 150	ºC
Lead Temperature (Soldering, 10 sec)		T_{LEAD}	260	ºC

Note:

1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Repetitive Rating: Pulse width limited by maximum junction temperature
3. I_{AS} = 15.0A, V_{DD} = 15V, R_G = 25Ω, Starting T_J = 25°C
4. I_{AS_Limit}= 36.0A, V_{DD} = 15V, R_G = 25Ω, Starting T_J = 25°C

Thermal Characteristics

Parameter	Symbol	Min	Typ	Max	Unit
Thermal Resistance，Junction-to-Case	R_{thJC}		0.65	1.4	ºC/W
Thermal Resistance，Junction-to-Ambient	R_{thJA}			62	

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Electrical Characteristics

T_J = 25℃, unless otherwise specified.

Parameter		Symbol	Test Conditions	Min	Typ	Max	Unit
Statistic Characteristics							
Drain-Source Breakdown Voltage		BV_{DSS}	V_{GS}=0V, I_D=250uA	30			V
Zero Gate Voltage Drain Current		I_{DSS}	V_{DS}=30V, V_{GS}=0V			1	uA
Gate-Body Leakage Current	Forward	I_{GSSF}	V_{GS}=20V, V_{DS}=0V			100	nA
	Reverse	I_{GSSR}	V_{GS}=-20V, V_{DS}=0V			-100	
Gate Threshold Voltage		$V_{GS(TH)}$	V_{DS}=V_{GS}, I_D=0.25mA	1.0	1.6	2.2	V
Static Drain-Source On-Resistance		$R_{DS(ON)}$	V_{GS}=4.5V, I_D=20A		1.95	2.7	mΩ
Static Drain-Source On-Resistance		$R_{DS(ON)}$	V_{GS}=10V, I_D=50A		1.35	1.6	mΩ
Gate Resistance		R_G	f=1MHz, Open Drain		1.3		Ω
Dynamic Characteristics							
Input Capacitance		C_{ISS}	V_{DS}=15V, V_{GS}=0V, f=1MHz		3.6		nF
Output Capacitance		C_{OSS}			800		pF
Reverse Transfer Capacitance		C_{RSS}			180		pF
Turn-on Delay Time		$t_{d(on)}$	V_{DD}=15V, I_D=50A R_G=1.6Ω, V_{GS}=10V		12		ns
Rise Time		t_r			9		
Turn-off Delay Time		$t_{d(off)}$			50		
Fall Time		t_f			9		
Gate Charge Characteristics							
Gate to Source Charge		Q_{gs}	V_{DD}=15V, I_D=50A V_{GS}=0 to 10V		6.6		nC
Gate to Drain Charge		Q_{gd}			6.2		
Gate Charge Total		Q_g			48.2		
Gate Plateau Voltage		$V_{plateau}$			2.8		V
Reverse Diode Characteristics							
Drain-Source Diode Forward Voltage		V_{SD}	V_{GS}=0V, I_{SD}=50A		0.81	1.1	V
Reverse Recovery Time		t_{rr}	V_R=15V, I_F=50A dI$_F$/dt=100A/us		31		ns
Reverse Recovery Charge		Q_{rr}			79		nC

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Sanrise Technology Limited Company

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